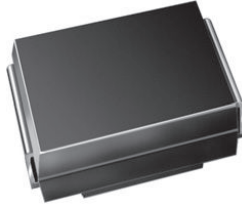


Surface Mount Ultrafast Rectifier



DO-214AA (SMB)



RoHS
COMPLIANT
HALOGEN
FREE

FEATURES

- Low profile package
- Ideal for automated placement
- Oxide planar chip junction
- Ultrafast recovery times for high frequency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds of AC/AC and DC/DC converters in high temperature conditions for both consumer and automotive applications.

MECHANICAL DATA

Case: DO-214AA (SMB)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2.0 A
V_{RRM}	100 V, 150 V, 200 V
I_{FSM}	50 A
t_{rr}	25 ns
V_F at $I_F = 2.0$ A	0.69 V
T_J max.	175 °C
Package	DO-214AA (SMB)
Diode variations	Single die

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)					
PARAMETER	SYMBOL	UH2B	UH2C	UH2D	UNIT
Device marking code		HB	HC	HD	
Maximum repetitive peak reverse voltage	V_{RRM}	100	150	200	V
Maximum average forward rectified current (fig. 1) ⁽¹⁾	$I_{F(AV)}$	2.0			A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	50			A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +175			°C

Note

⁽¹⁾ Free air, mounted on recommended copper pad area

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 1.0 A	T _A = 25 °C	V _F ⁽¹⁾	0.79	-	V	
	I _F = 2.0 A			0.87	1.05		
	I _F = 1.0 A	T _A = 125 °C		0.62	-		
	I _F = 2.0 A			0.69	0.90		
Reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	2.0	μA	
		T _A = 125 °C		10	50		
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	15	25	ns	
Typical reverse recovery time	I _F = 1.0 A, dI/dt = 50 A/μs, V _R = 30 V, I _{rr} = 0.1 I _{RM}			20	35		
Typical softness factor (t _b /t _a)			S	0.3	-		
Typical reverse recovery current	I _F = 2.0 A, dI/dt = 200 A/μs, V _R = 200 V		T _A = 125 °C	I _{RM}	5.0	6.0	A
Typical stored charge				Q _{rr}	55	-	nC
Typical junction capacitance	4.0 V, 1 MHz		C _J	42	-	pF	

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
 (2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	UH2B	UH2C	UH2D	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾	105			°C/W
	R _{θJM} ⁽¹⁾	15			

Note

- (1) Free air, mounted on recommended copper pad area. Thermal resistance R_{θJA} - junction to ambient, R_{θJM} - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
UH2D-M3/52T	0.100	52T	750	7" diameter plastic tape and reel
UH2D-M3/5BT	0.100	5BT	3200	13" diameter plastic tape and reel

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

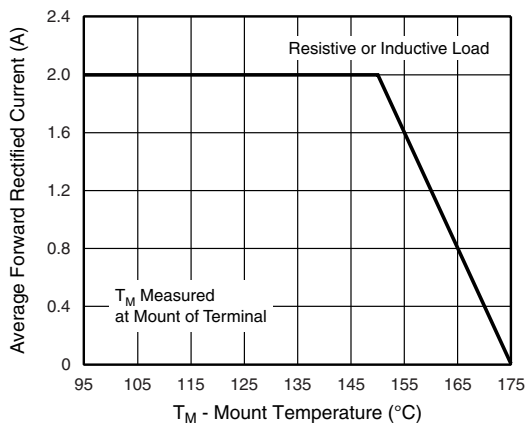


Fig. 1 - Maximum Forward Current Derating Curve

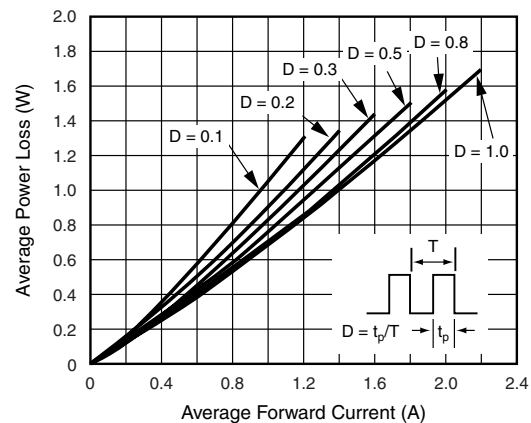


Fig. 2 - Forward Power Loss Characteristics

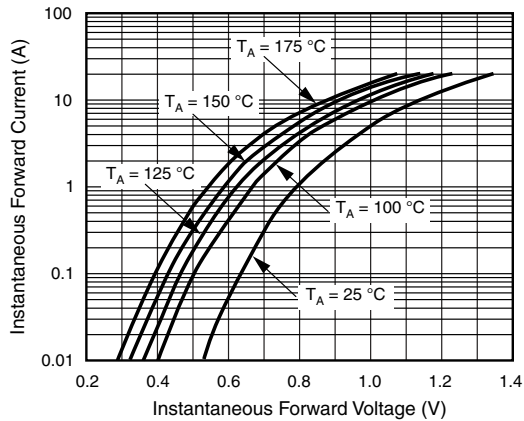


Fig. 3 - Typical Instantaneous Forward Characteristics

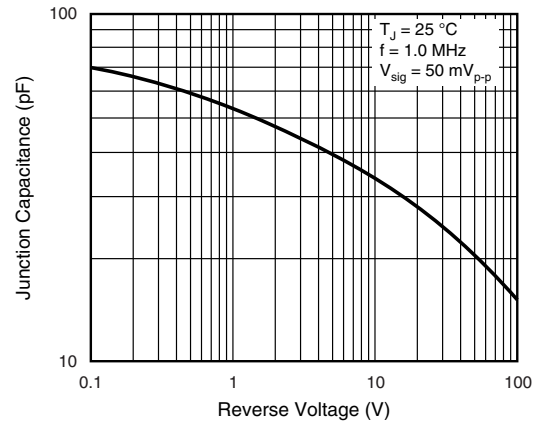


Fig. 5 - Typical Junction Capacitance

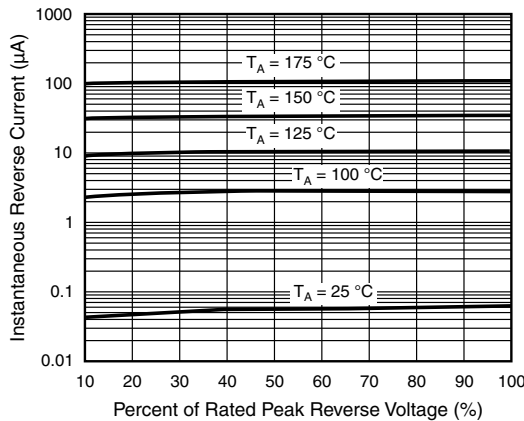


Fig. 4 - Typical Reverse Characteristics

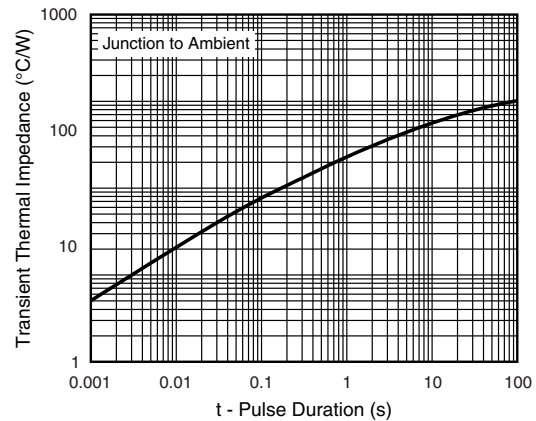
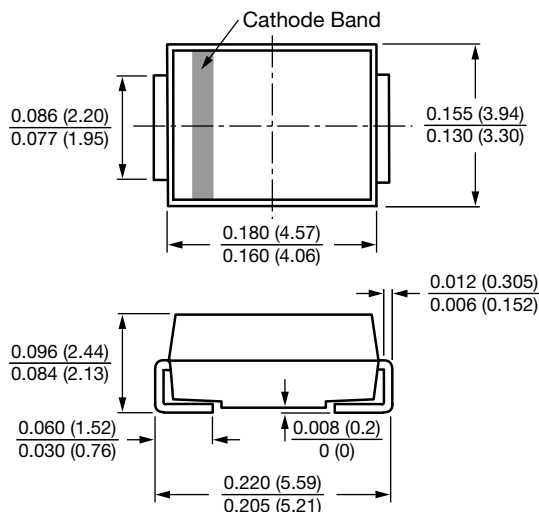


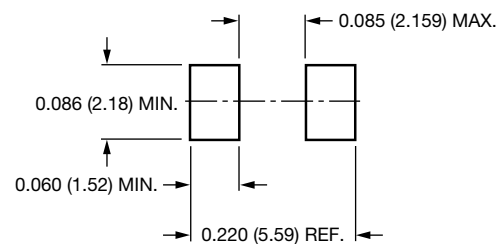
Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AA (SMB)



Mounting Pad Layout





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